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Customer No.: 31561
Application No.: 10/605,163
Docket No.: 10230-US-PA

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Application of:

WANG, SUNG-FEI

Serial No.: 10/605,163

Filed: 09/12/2003

For: SEMICONDUCTOR PACKAGE WITH
A HEAT SPREADER

Examiner: WILLIAMS, ALEXANDER O

Art Unit: 2826

Docket No.: 10230-US-PA

No fee is believed to be due. However, the Commissioner is authorized to charge any fees required in connection with the filing of this paper to account No. 50-2620 (Order No.: 10230-US-PA)

REQUEST FOR CONTINUED EXAMINATION/ PRELIMINARY AMENDMENT

U.S. Patent and Trademark Office
Commissioner for Patents
Customer Service Window Mail Stop RCE
Randolph Building, 401 Dulany Street
Alexandria, VA 22314

Sir:

The Advisory Action mailed May 4, 2005 has been carefully considered. In response thereto, Applicant respectfully files a Request for Continued Examination (RCE). Please enter the following amendments and consider the following remarks.

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AMENDMENTS

In the Title:

Please amend the previously presented title of the invention: "MULTI-CHIP MODULE PACKAGE" to "SEMICONDUCTOR PACKAGE WITH A HEAT SPREADER".